

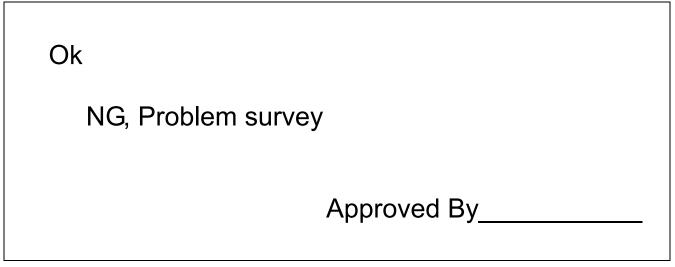


SPECIFICATION

Product Model:PV101037Y0130A

DESIGNED	CHECKED	Approved
研发部	研发部	研发部
2020.11.18	2020.11.18	2020.11.18
Aleck	Hones	Mike

Approval by Customer:







Revision Record

REV NO.	REV DATE	CONTENTS	Note
V0	2020.11.18	NEW ISSUE	





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1. Scope

This specification defines general provisions as well as inspection standards for TFT module supplied by Kingtech Group Co.,Ltd.

If the event of unforeseen problem or unspecified items may occur, naturally shall negotiate and agree to solution.

2. General Information

ITEM	STANDARD VALUES	UNITS
LCD type	10.1"TFT	
Dot arrangement	1024×3 (RGB)×600	dots
Color filter array	RGB vertical stripe	
Display mode	Normally White	
Viewing Direction	6 O' Clock	
Module size	235(W)×143(H)×4.55(T)	mm
Active area	222.72(W)×125.28(H)	mm
Dot pitch	0.2175(W)×0.2088(H)	mm
Interface	MIPI	
Operating temperature	-20 ~ +70	°C
Storage temperature	-30 ~ +80	°C
Module Weight		g



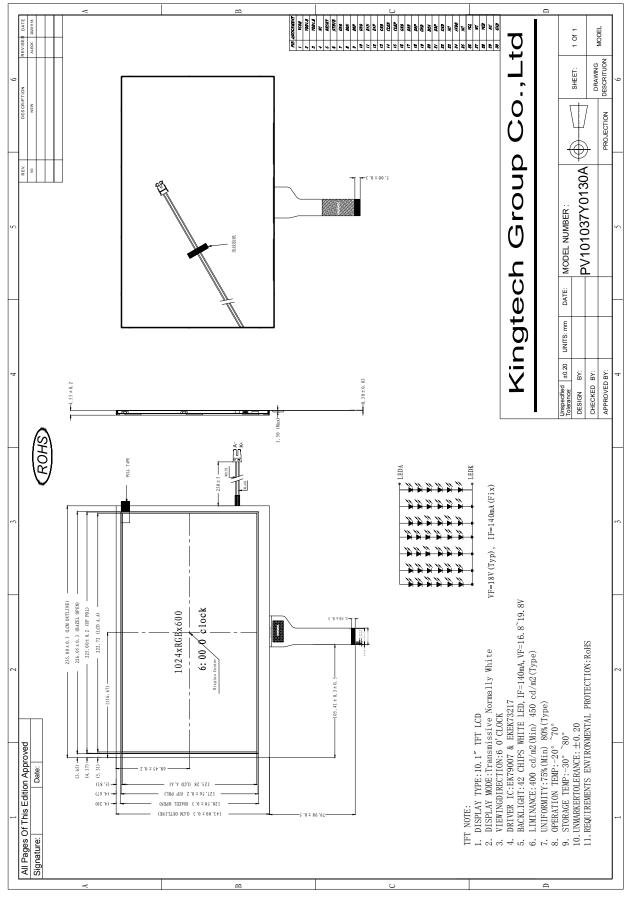
Professional LCD Module Manufacturer since 2003

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3. External Dimensions







4. Interface Description

PIN	PIN NAME	DESCRIPTION
1	VCOM	Common Voltage.
2	VDD1.8	Digital Power 1.8V.
3	VDD1.8	Digital Power 1.8V.
4	NC	No Connect
5	RESET	Global reset pin. Active low to enter reset state. Suggest to connecting with an RC reset circuit for stability. Normally pull high.(R=10K Ω , C=1 μ F)
6	STBYB	Standby mode. STBYB = "H" ,normal operation(default) STBYB = "L" , timing controller, source driver will turn off, all output are High-Z.
7	GND	Power ground.
8	D0N	MIPI differential data lane 0 input (Negative).
9	D0P	MIPI differential data lane 0 input (Positive).
10	GND	Power ground.
11	D1N	MIPI differential data lane 0 input (Negative).
12	D1P	MIPI differential data lane 0 input (Positive).
13	GND	Power ground.
14	CLKN	MIPI differential clock input (Negative).
15	CLKP	MIPI differential clock input (Positive).
16	GND	Power ground.
17	D2N	MIPI differential data lane 0 input (Negative).
18	D2P	MIPI differential data lane 0 input (Positive).
19	GND	Power ground.
20	D3N	MIPI differential data lane 0 input (Negative).
21	D3P	MIPI differential data lane 0 input (Positive).
22	GND	Power ground.
23	NC	No Connect
24	AVDD	Analog Power.
25	NC	No Connect
26	VGL	Negative Power for TFT.
27	NC	No Connect
28	VGH	Positive Power for TFT.
29	NC	No Connect
30	GND	Power ground.





5. Absolute Maximum Ratings

Item	Symbol	Min.	Max.	Unit
Digital Supply Voltage	VDD	-0.3	2.0	V
Analog Supply Voltage	AVDD	6.5	13.5	V
Gate On Voltage	VGH	-0.3	40.0	V
Gate Off Voltage	VGL	-20.0	0.3	V
Gate On- Gate Off Voltage	VGH-VGL	-	40.0	V
Operating Temperature	Тор	-20	70	°C
Storage Temperature	Тѕт	-30	80	°C
Storage Humidity	HD	20	90	%RH

6. DC Characteristics

Operating Conditions

Item	Symbol	Min.	Тур.	Max.	Unit	Remark
Digital Supply Voltage	VDD1.8	1.71	1.8	1.89	V	-
Analog Supply Voltage	AVDD	8.6	9.0	9.4	V	-
Gate On Voltage	VGH	-	17.0	-	V	-
Gate Off Voltage	VGL	-	-10	-	V	-
Common Voltage	VCOM	3.5	3.9	4.3	V	-
	VIH	0.7DVDD	-	DVDD	V	-
Logic Input Voltage	VIL	GND	-	0.3DVDD	V	-

NOTE1: VCOM 电压根据客户主板实际效果而定





7. Timing Characteristics

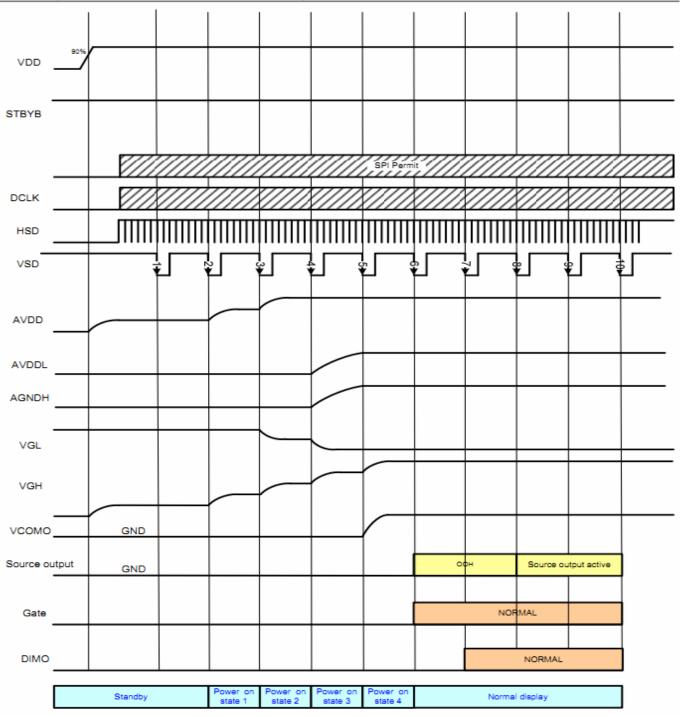
7.1 POWER ON/OFF SEQUENCE

To prevent the device damage from latch up, the power on/off sequence shown below must be followed.

Power on: VDD, GND _ AVDD, AGND _ V1 to V14

Power off: V1 to V14 _ AVDD, AGND_ VDD, GND

Power on/off control



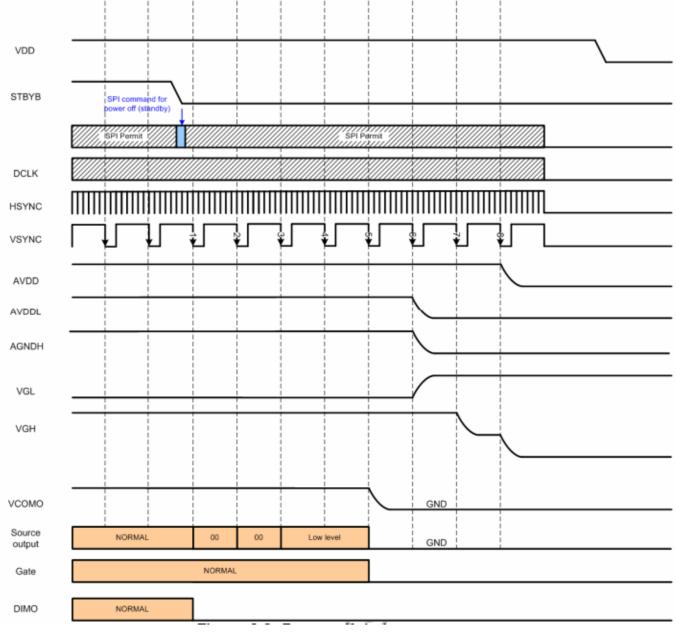
Power on timing sequence



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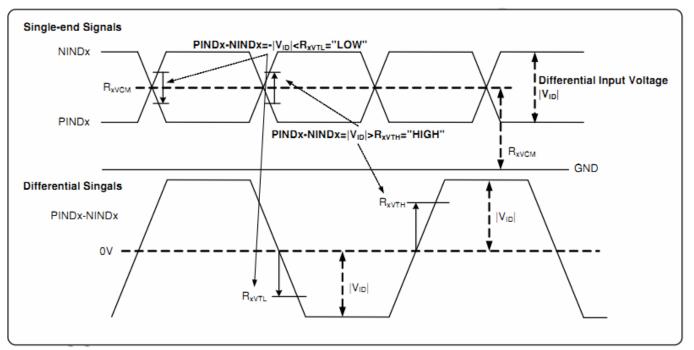
7.2 INPUT SIGNAL TIMING

7.2.1 DC electrical characteristics

LVDS mode DC electrical characteristics

Parameter	Symbol		Spec.		Unit	Condition
Farameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Differential input high Threshold voltage	R _{XVTH}	-	-	+0.1	V	R _{XVCM} =1.2V
Differential input low threshold voltage	R _{XVTL}	-0.1	-	-	V	
Input voltage range (singled-end)	R _{XVIN}	0	-	VDD-1.2+ V _{ID} /2	V	-
Differential input common Mode voltage	R _{XVCM}	V _{ID} /2	-	VDD-1.2	V	-
Differential input voltage	V _{ID}	0.2	-	0.6	V	-
Differential input leakage Current	RV _{Xliz}	-10	-	+10	μA	-
LVDS Digital Operating Current	lddlvds	-	15	30	mA	Fclk=65MHz, VDD=3.3V
LVDS Digital Stand-by Current	Istlvds	-	10	50	μA	Clock & all Functions are stopped

Single-end signals



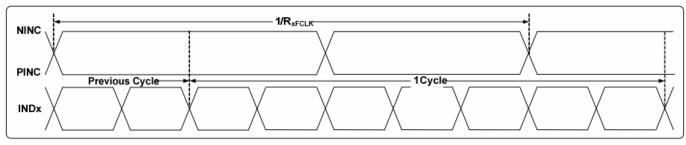


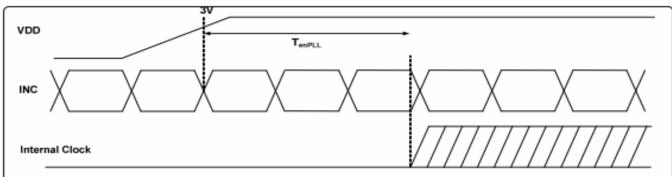


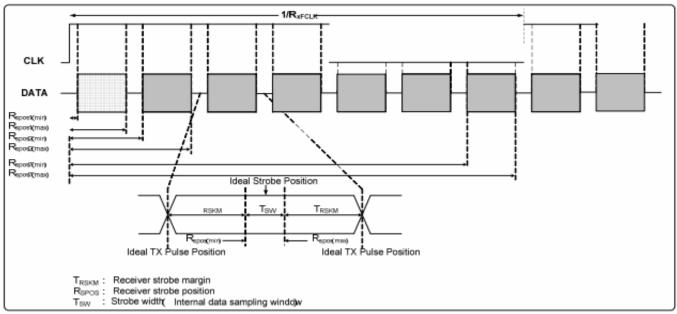
7.2.2AC ELECTRICAL CHARACTERISTICS

LVDS mode AC electrical characteristics

Parameter	Symbol		Spec.		Unit	Condition
Farameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Clock frequency	RXFCLK	20	-	71	MHz	-
Input data skew margin	T _{RSKM}	500	-	-	pS	V _{ID} =400mV R _{XVCM} =1.2V R _{XFCLK} =71MHz
Clock high time	TLVCH	-	4/(7* R _{XFCLK})	-	ns	-
Clock low time	TLVCL		3/(7* R _{XFCLK})	-	ns	-
PLL wake-up time	T _{enPLL}	-	-	150	μs	-





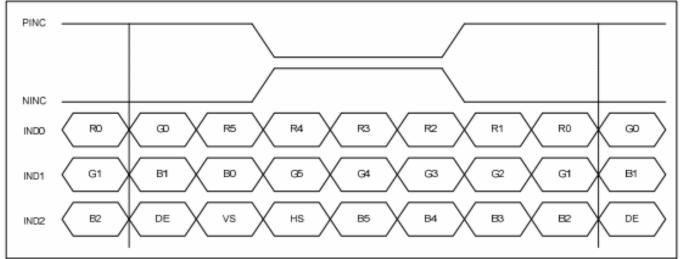


LVDS mode data input format

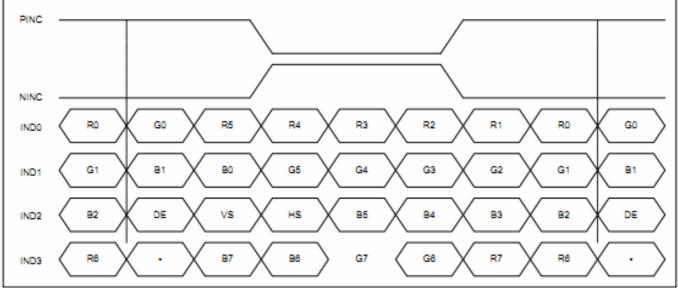




7.2.3LVDS mode data input format



6-bit LVDS input



8-bit LVDS input

7.3 PARALLEL RGB INPUT TIMING TABLE DE mode (1024x600)

Parameter	Symbol		Unit		
Farameter	Symbol	Min.	Тур.	Max.	Unit
DCLK Frequency	fclk	40.8	51.2	67.2	MHz
Horizontal Display Area	thd		1024		DCLK
HSD Period	th	1114	1344	1400	DCLK
HSD Blanking	thb+ thfp	90	320	376	DCLK
Vertical Display Area	tvd		600		T _H
VSD Period	tv	610	635	800	T _H
VSD Blanking	tvbp+ tvfp	10	35	200	T _H

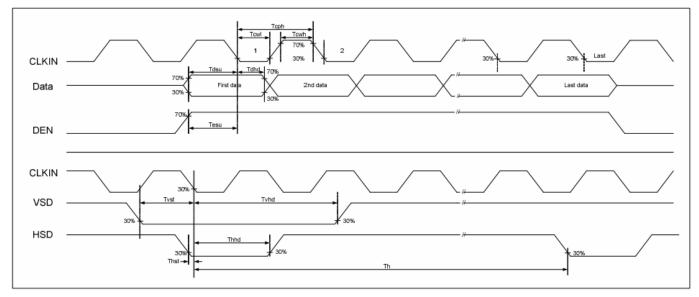




nE				
Symbol		Value		Unit
that		1024		DCLK
	Min.) Typ.	Max.	
	449	51.2	63	Mhz
(Th	200	1344	1400	
1 NC	2	1	-	
hpw		_		DCLK
<u>\</u>		140		DOLK
thb	160	160	160]
thfp	16	160	216	
	the fclk thp thpw	the the the test	the 1024 fclk Min. Typ. fclk 449 51.2 th 1200 1344 1 1 thpw - 140 160	thick 1024 fclk Max. fclk 51.2 63 th 1200 1344 1400 1 1 1 1 140 140 thb 160 160 160

7.4 TIMING DIAGRAM

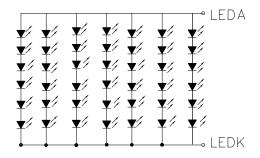
Input Clock and Data Timing Diagram







8. Backlight Characteristics



VF = 18V(Typ), IF = 140mA(Fix)

Item	Symbol	MIN	TYP	MAX	UNIT	Test Condition
Supply Voltage	Vf	16.8	18.0	19.8	V	lf=140mA
Supply Current	lf	-	140	-	mA	lf=140mA
Luminous Intensity for LCM	-	400	450	-	cd/m ²	lf=140mA
Uniformity for LCM	-	75	80	-	%	lf=140mA
Life Time	-	30000	-	-	Hr	lf=140mA

9. Optical Characteristics

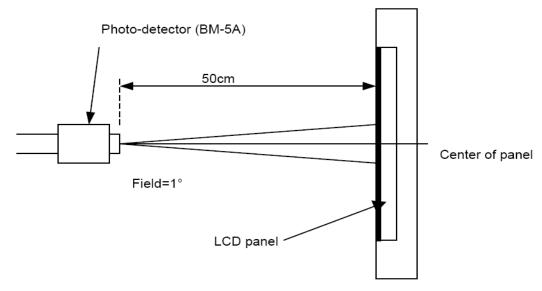
Item	Conditions		Min.	Тур.	Max.	Unit	Note
Viewing Angle (CR>10)	Horizontal	θL	60	75	-	degree	(1),(2),(6)
		θR	60	75	-		
	Vertical	θт	55	70	-		
		θв	45	70	-		
Contrast Ratio	Center		600	800	-	-	(1),(3),(6)
Transmittance Tr			5.0	5.5		%	Base on BLU Light Note (7))
Response Time	Rising + Falling		25	35	-	ms	(1),(4),(6)
	Red x			0.608		-	
	Red y	ed y		0.330	Typ. +0.05	-	(1), (6)
	Green x Green y Blue x			0.298		-	
CF Color Chromaticity			Тур.	0.562		-	
Chromaticity (CIE1931)			-0.05	0.145		-	
	Blue y			0.163		-	
	White x			0.304		-	
	White y			0.339		-	

Note (1) Measurement Setup: The LCD module should be stabilized at given temp. 25°C for 15 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting backlight for 15 minutes in a

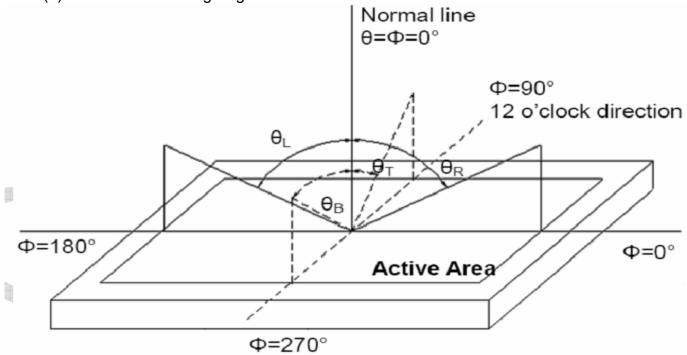


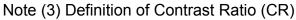


windless room.



Note (2) Definition of Viewing Angle



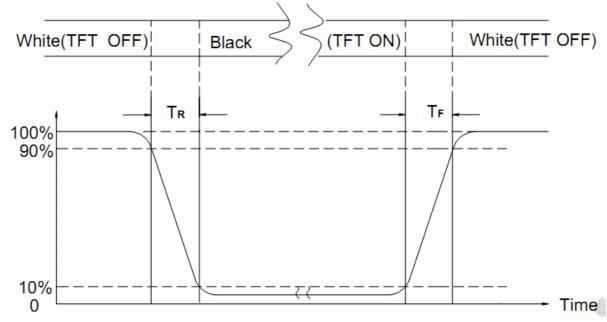


The contrast ratio can be calculated by the following expression Contrast Ratio (CR) = L63 / L0





L63: Luminance of gray level 63, L0: Luminance of gray level 0 Note (4) Definition of response time



Note (5) Definition of Transmittance (Module is without signal input) Transmittance = Center Luminance of LCD / Center Luminance of Back Light x 100%

Note (6) Definition of color chromaticity (CIE1931)

Color coordinates measured at the center point of LCD





10. Reliability Test Conditions and Methods

NO.	TEST ITEMS	TEST CONDITION		
1	High Temperature Storage	Keep in 80°C $\pm 5^{\circ}$ C 240 hrs Surrounding temperature, then storage at normal condition 4hrs.		
2	Low Temperature Storage	Keep in -30°C \pm 5°C 240 hrs Surrounding temperature, then storage at normal condition 4hrs.		
3	High Temperature / High Humidity Storage Test	Keep in 60 $^{\circ}$ C / 90% R.H duration for 240 hrs Surrounding temperature, then storage at normal condition 4hrs. (Excluding the polarizer)		
(4)	Temperature Cycling Storage Test	$\begin{array}{ccccc} -30^{\circ}\text{C} \rightarrow & +25^{\circ}\text{C} \rightarrow & 80^{\circ}\text{C} \rightarrow & +25^{\circ}\text{C} \\ (30 \text{mins}) & (5 \text{mins}) & (30 \text{mins}) & (5 \text{mins}) \\ \hline & & 30 \text{ Cycle} \\ \end{array}$ Surrounding temperature, then storage at normal condition 4hrs.		
5	ESD Test	Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/-Contact Discharge: Apply 250 V with 5 times discharge for each polarity +/-1. Temperature ambiance : $15^{\circ}C \sim 35^{\circ}C$ 2. Humidity relative : $30\% \sim 60\%$ 3. Energy Storage Capacitance(Cs + Cd) : $150pF\pm10\%$ 4. Discharge Resistance(Rd) : $330\Omega\pm10\%$ 5. Discharge, mode of operation : Single Discharge (time between successive discharges at least 1 sec)		
6	Vibration Test (Packaged)	 Sine wave 10~55 Hz frequency (1 min/sweep) The amplitude of vibration :1.5 mm Each direction (X、Y、Z) duration for 2 Hrs 		
7	Drop Test (Packaged)	Packing Weight (Kg) Drop Height (cm) $0 \sim 45.4$ 122 $45.4 \sim 90.8$ 76 $90.8 \sim 454$ 61 Over 454 46 Drop ::::1 corner / 3 edges / 6 sides each 1time		



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11. Inspection Standard

11.1. QUALITY :

THE QUALITY OF GOODS SUPPLIED TO PURCHASER SHALL COME UP TO THE FOLLOWING STANDARD.

11.1.1. INSPECTIONTOOLS AND INSTRUMENTS

Vernier calipers, film scales, multimeter, magnifying eyepiece, ND5%, luminance meter and so on.

11.1.2. THE METHOD OF PRESERVING GOODS

AFTER DELIVERY OF GOODS FROM KINGTECH TO PURCHASER. PURCHASER SHALL CONTROL THE LCM AT -10 TO 40 ,AND IT MIGHT BE DESIRABLE TO KEEP AT THE NORMAL ROOM TEMPERATURE AND HUMIDITY UNTIL INCOMING INSPECTION OR THROWING INTO PROCESS LINE.

11.1.3. INCOMING INSPECTION

(A) THE METHOD OF INSPECTION

IF PURCHASER MAKE AN INCOMING INSPECTION , A SAMPLING PLAN SHALL BE APPLIED ON THE CONDITION THAT QUALITY OF ONE DELIVERY SHALL BE REGARDED AS ONE LOT.

(B) THE STANDARD OF QUALITY

ISO-2859-1 (SAME AS MIL-STD-105E) ,LEVEL:

CLASS	AQL(%)
CRITICAL	0.4 %
MAJOR	0.65 %
MINOR	1.5 %

EVERY ITEM SHALL BE INSPECTED ACCORDING TO THE CLASS. (C) MEASURE

IF AS THE RESULT OF ABOVE RECEIVING INSPECTION , A LOT OUT IS DISCOVERED. PURCHASER SHALL BE INFORM SELLER OF IT WITHIN SEVEN DAYS. BUT FIRST SHIPMENT WITHIN FOURTEEN DAYS.

11.1.4. WARRANTY POLICY

KINGTECH WILL PROVIDE ONE-YEAR WARRANTY FOR THE PRODUCTS ONLY IF UNDER SPECIFICATION OPERATING CONDITIONS. KINGTECH WILL REPLACE NEW PRODUCTS FOR THESE DEFECT PRODUCTS WHICH UNDER WARRANTY PERIOD AND BELONG TO THE RESPONSIBILITY OF KINGTECH.

11.2. CHECKING CONDITION

- **11.2.1.**CHECKING DIRECTION SHALL BE IN THE 45 DEGREE AREA TO FACE THE SAMPLE.
- **11.2.2.**CHECKER SHALL SEE OVER 300±25 mm. WITH BARE EYES FAR FROM SAMPLE **11.2.3.**Ambient Illumination:

0~30 Lux for functional inspection

11.2.5. Inspection should be carried out with

rope electrostatic ring and static finger cover

(both hands except small fingers must be worn)

500 ~ 1200 Lux for external appearance inspection.

-**>**

11.2.4. TEST AREA:

11.2.6. The inspector may make a visual inspection or a comparative examination with a film





ruler and a magnifying eyepiece. Individual defects shall be determined according to the limited samples.

11.2.7. Functional testing uses electrical testing fixtures or test fixtures required by customers.

11.2.8. the ion fan should be used when testing.

11.2.9. the principle of judgment

11.3.1 If the defect outside the visual area does not affect the assembly and display, it will be judged as a good product.

11.3.2 Poor definitionPixel:A combination of three sub-pixels (Red + Green + Blue).

Dot:

Any of the sub-pixels (Red or Green or Blue).

Bright and dark dots:

A point pixel (sub-pixel: R, G, B pixels) is lit or turned off during the display function test. **Highlights**:

Usually considered to be shown on a black screen.

Dark spots:

They are generally considered to be shown on R, G, B solid colors or white images. **Neighborhood**:

Two or three adjacent point pixels (dot: sub-pixel) connected together (R, G or G, B or B, R or RGB).





11.3. INSPECTION PLAN :

		,	
CLASS	ITEM	JUDGEMENT	CLASS
PACKING &	1. OUTSIDE AND INSIDE PACKAGE	"MODEL NO." , "LOT NO." AND "QUANTITY" SHOULD INDICATE ON THE PACKAGE.	Minor
INDICATE	2. MODEL MIXED AND QUANTITY	OTHER MODEL MIXEDREJECTED	Critical
	3. PRODUCT INDICATION	"MODEL NO." SHOULD INDICATE ON THE PRODUCT	Major
ASSEMBLY	4. DIMENSION, LCD GLASS SCRATCH AND SCRIBE DEFECT.	ACCORDING TO SPECIFICATION OR DRAWING.	Major
	5. VIEWING AREA	POLARIZER EDGE OR LCD'S SEALING LINE IS VISABLE IN THE VIEWING AREA REJECTED	Minor
	6. BLEMISH - BLACK SPOT - WHITE SPOT IN THE LCD AND LCD GLASS CRACKS	ACCORDING TO STANDARD OF VISUAL INSPECTION(INSIDE VIEWING AREA)	Minor
APPEARANCE	7. BLEMISH • BLACK SPOT WHITE SPOT AND SCRATCH ON THE POLARIZER	ACCORDING TO STANDARD OF VISUAL INSPECTION(INSIDE VIEWING AREA)	Minor
	8. BUBBLE IN POLARIZER	ACCORDING TO STANDARD OF VISUAL INSPECTION(INSIDE VIEWING AREA)	Minor
	9. LCD'S RAINBOW COLOR	STRONG DEVIATION COLOR (OR NEWTON RING) OF LCDREJECTED. OR ACCORDING TO LIMITED SAMPLE (IF NEEDED, AND INSIDE VIEWING AREA)	Minor
	10. ELECTRICAL AND OPTICAL CHARACTERISTICS (CONTRAST, VOP, CHROMATICITY ETC)	ACCORDING TO SPECIFICATION OR DRAWING . (INSIDE VIEWING AREA)	Critical
ELECTRICAL	11.MISSING LINE	MISSING DOT LINE CHARACTER	Critical
	12.SHORT CIRCUIT- WRONG PATTERN DISPLAY	NO DISPLAY VRONG PATTERN DISPLAY CURRENT CONSUMPTION OUT OF SPECIFICATION REJECTED	Critical
	13. DOT DEFECT (FOR COLOR AND TFT)		Minor



11.4. STANDARD OF VISUAL INSPECTION

NO.	CLASS	ITEM	JUDGE	MENT	
			(A) ROUND TYPE:	unit : mm.	
			DIAMETER (mm.) AC	ACCEPTABLE Q'TY	
			Φ ≤ 0.15	Distance>1mm	
		DI ACK AND MUTE COOT	0.15 < Φ ≦ 0.4	3 (Distance>15mm)	
		BLACK AND WHITE SPOT FOREIGN MATERIEL DUST IN THE CELL BLEMISH	0.4 < Φ	0	
11.4.1 MINOR	MINOR		NOTE: Ф=(LENGTH+WIDTH)/2 (B) LINEAR TYPE:	unit : mm.	
		SCRATCH	LENGTH WIDTH	ACCEPTABLE Q'TY	
		boltarion	W ≦0	0.03 Distance>1mm	
			L≦4.0 0.03 < W ≦0	0.05 3 (Distance>15mm)	
			0.05 < W	FOLLOW ROUND TYPE	
2		5		unit : mm.	
			DIAMETER	ACCEPTABLE Q'TY	
		BUBBLE IN POLARIZER	Φ ≤ 0.2	Distance≥1mm	
11.4.2	MINOR		0.2 < Φ ≤ 0.5	3 (Distance>15mm)	
			0.5 < Φ	0	
		Dot Defect	Items Bright dot	ACC. Q'TY N≤2 (Distance>15mm)	
				N≦2 (Distance≥15mm)	
11.4.3 M	MINOR		Pixel Define : Pixel Pixel Pixel Pixel Pixel Pixel R G + Dot → Dot + Dot → Dot + Dot → Dot + Note 1: The definition of dot: The s 1/2 of whole dot is regarded Definittion:<1/2dot and vi Note 2: Bright dot: Dots appear brid in which LCD panel is disp Note 3: Dark dot: Dots appear dark	B ize of a defective dot over a sone defective dot. sible by 5 % ND filter N ≤ 5 ght and unchanged in size laying under black pattern.	
1,4,4	MINOR	Mura	Not visible thriugh 5% ND filter by limit sample if necessary	in 50% gray or judge	





NO.	CLASS	ITEM	JUDGEMENT
11.4.5	MINOR	LCD GLASS CHIPPING	X≥3mm Y>S Reject
11.4.6	MINOR	LCD GLASS CHIPPING	X or Y > S Reject
11.4.7	MAJOR	LCD GLASS GLASS CRACK	T T NG Reject
11.4.8	MAJOR	LCD GLASS SCRIBE DEFECT	
11.4.9	MINOR	LCD GLASS CHIPPING (ON THE TERMINAL AREA)	$Y < 1/2Z$ $Y \ge 0.5mm_{Reject}$ $X \ge 3mm$
11.4.10	MINOR	LCD GLASS CHIPPING (ON THE TERMINAL SURFACE)	$Y < 1/2Z$ $Y \ge 0.5mm$ $Reject$ $X \ge 3mm$
11.4.11	MINOR	LCD GLASS CHIPPING	$X \ge 3mm$ $Y \ge T$ Reject $X \ge 1$ If touch the electrode lines, the need to retain the two-thirds electrode lines



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12. Handling Precautions

12.1 Mounting method

The LCD panel of KINGTECH TFT module consists of two thin glass plates with polarizes which easily be damaged. And since the module in so constructed as to be fixed by utilizing fitting holes in the printed circuit board.

Extreme care should be needed when handling the LCD modules.

12.2 Caution of LCD handling and cleaning

When cleaning the display surface, Use soft cloth with solvent

- [Recommended below] and wipe lightly
- Isopropyl alcohol
- Ethyl alcohol

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

Do not use the following solvent:

- Water
- Aromatics

Do not wipe ITO pad area with the dry or hard materials that will damage the ITO patterns Do not use the following solvent on the pad or prevent it from being contaminated:

- Soldering flux
- Chlorine (Cl) , Sulfur (S)

If goods were sent without being silicon coated on the pad, ITO patterns could be damaged due to the corrosion as time goes on.

If ITO corrosion happen by miss-handling or using some materials such as Chlorine (CI), Sulfur (S) from customer, Responsibility is on customer.

12.3 Caution against static charge

The LCD module use C-MOS LSI drivers, so we recommended that you:

Connect any unused input terminal to POWER or GROUND, do not input any signals before power is turned on, and ground your body, work/assembly areas, and assembly equipment to protect against static electricity.

12.4 packing

- Module employs LCD elements and must be treated as such.
- Avoid intense shock and falls from a height.
- To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity

12.5 Caution for operation

- It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life.
- An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- Response time will be extremely delayed at lower temperature then the operating temperature range and on the other hand at higher temperature LCD's how dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operation temperature.
- If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- Slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.

Usage under the maximum operating temperature, 50%Rh or less is required.





12.6 storing

In the case of storing for a long period of time for instance, for years for the purpose or replacement use, the following ways are recommended.

- Storage in a polyethylene bag with the opening sealed so as not to enter fresh air outside in it. And with no desiccant.
- Placing in a dark place where neither exposure to direct sunlight nor light's keeping the storage temperature range.
- Storing with no touch on polarizer surface by the anything else.
 [It is recommended to store them as they have been contained in the inner container at the time of delivery from us

12.7 Safety

- It is recommendable to crash damaged or unnecessary LCD's into pieces and wash off liquid crystal by either of solvents such as acetone and ethanol, which should be burned up later.
- When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water

13. Precaution for Use

13.1

A limit sample should be provided by the both parties on an occasion when the both parties agreed its necessity. Judgment by a limit sample shall take effect after the limit sample has been established and confirmed by the both parties.

13.2

On the following occasions, the handing of problem should be decided through discussion and agreement between responsible of the both parties.

- When a question is arisen in this specification
- When a new problem is arisen which is not specified in this specifications
- When an inspection specifications change or operating condition change in customer is reported to KINGTECH TFT, and some problem is arisen in this specification due to the change
- When a new problem is arisen at the customer's operating set for sample evaluation in the customer site.

14. Packing Method TBD